

## 4N60K-MK

Preliminary

# 4A, 600V N-CHANNEL POWER MOSFET

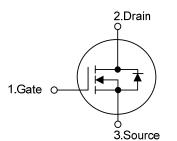
## DESCRIPTION

The UTC **4N60K-MK** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

#### FEATURES

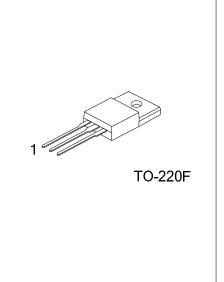
- \*  $R_{DS(ON)}$  < 2.5 $\Omega$  @V<sub>GS</sub> = 10 V
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, high Ruggedness

### SYMBOL









#### Preliminary

#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	600	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Avalanche Current (Note 2)		I <sub>AR</sub>	4.4	А
Drain Current	Continuous	I <sub>D</sub>	4.0	А
	Pulsed (Note 2)	I <sub>DM</sub>	16	А
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	160	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation		P <sub>D</sub>	36	W
Derate above 25°C			0.288	W/°C
Junction Temperature		ΤJ	+150	°C
Operating Temperature		T <sub>OPR</sub>	-55 ~ +150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. L = 20mH,  $I_{AS}$  = 4A,  $V_{DD}$  = 50V,  $R_G$  = 25  $\Omega$ , Starting  $T_J$  = 25°C

4.  $I_{SD} \leq 4.4A$ , di/dt  $\leq 200A/\mu s$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ <sub>JA</sub>	62.5	°C/W	
Junction to Case	θις	3.47	°C/W	



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#### ■ ELECTRICAL CHARACTERISTICS (T<sub>c</sub>=25°C, unless otherwise specified)

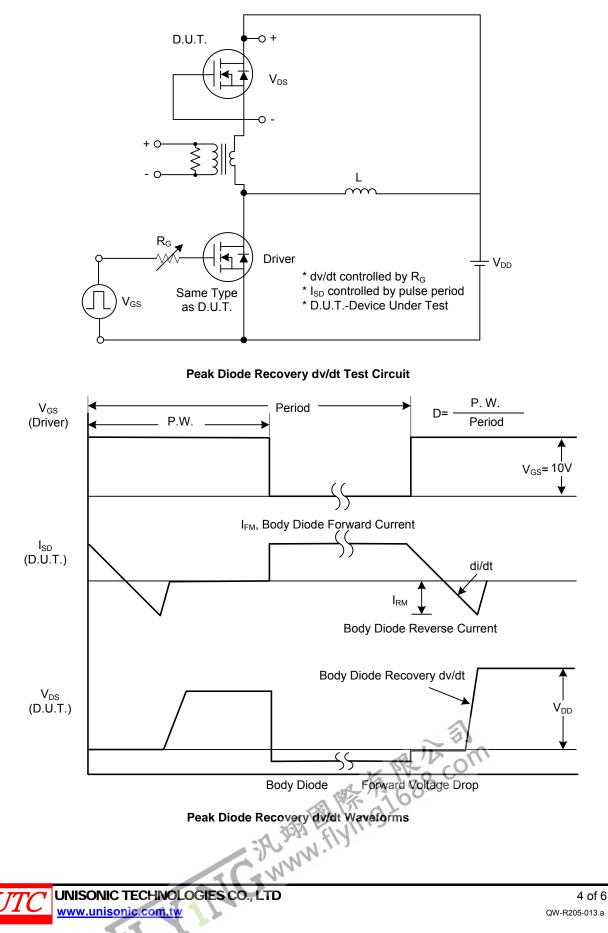
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	<del>)</del>	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	600			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V			10	μA
			V <sub>DS</sub> =600V, V <sub>GS</sub> =0V, T <sub>C</sub> =125°C			10	μA
Cata Sauraa Laakaga Currant	Forward	I <sub>GSS</sub>	V <sub>GS</sub> =30V, V <sub>DS</sub> =0V			100	nA
Gate-Source Leakage Current	Reverse		V <sub>GS</sub> = -30V, V <sub>DS</sub> =0V			-100	nA
Breakdown Voltage Temperature	Coefficient	$\bigtriangleup BV_{\text{DSS}} / \bigtriangleup T_{\text{J}}$	I <sub>D</sub> =250µA,Referenced to 25°C		0.6		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.5		4.5	V
Static Drain-Source On-State Res	sistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10 V, I <sub>D</sub> =2.2A			2.5	Ω
DYNAMIC CHARACTERISTICS					-		
Input Capacitance		C <sub>ISS</sub>	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1MHz		477	575	рF
Output Capacitance		C <sub>OSS</sub>			50	75	pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			5.82	11	рF
SWITCHING CHARACTERISTIC	S						
Turn-On Delay Time		t <sub>D(ON)</sub>			45		ns
Turn-On Rise Time		t <sub>R</sub>	$V_{DD} = 300V, I_D = 4.0A,$		38		ns
Turn-Off Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> = 25Ω (Note 1, 2)		98		ns
Turn-Off Fall Time		t⊧			30		ns
Total Gate Charge		$Q_{G}$	$V_{DS}$ = 480V,I <sub>D</sub> = 4.0A,		17.7		nC
Gate-Source Charge		$Q_{GS}$			6		nC
Gate-Drain Charge		$Q_{GD}$	V <sub>GS</sub> = 10V (Note 1, 2)		3		nC
SOURCE- DRAIN DIODE RATIN	IGS AND CI	HARACTERIS	TICS				
Drain-Source Diode Forward Volt	tage	$V_{SD}$	$V_{GS} = 0V, I_{S} = 4.4A$			1.4	V
Maximum Continuous Drain-Sou	rce Diode	I <sub>S</sub>				4.4	А
Forward Current						4.4	A
Maximum Pulsed Drain-Source Diode		I <sub>SM</sub>				17.6	А
Forward Current						17.0	

Notes: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%

2. Essentially independent of operating temperature

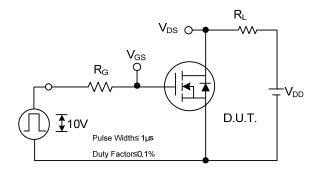


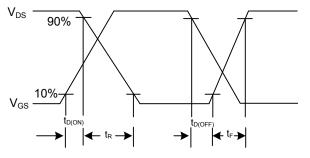
### TEST CIRCUITS AND WAVEFORMS



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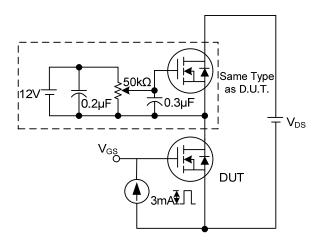
## **TEST CIRCUITS AND WAVEFORMS (Cont.)**



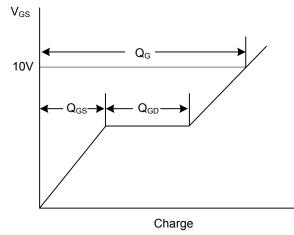


Switching Test Circuit

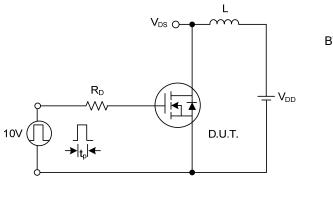




**Gate Charge Test Circuit** 

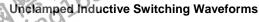


**Gate Charge Waveform** 



 $\mathsf{BV}_{\mathsf{DSS}}$  $I_{AS}$ I<sub>D(t)</sub>  $V_{\text{DS(t)}}$  $V_{\text{DD}}$ Time





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